Unit in mm

#### TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# 2SC2879A

### 2~30MHz SSB LINEAR POWER AMPLIFIER APPLICATIONS (LOW SUPPLY VOLTAGE USE)

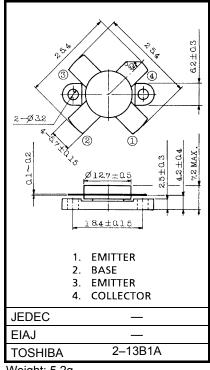
Specified 12.5V, 28MHz Characteristics

Output Power  $: Po = 100W_{PEP}$ Power Gain : Gp = 13dBCollector Efficiency  $: \eta_C = 35\% \text{ (Min.)}$ Intermodulation Distortion: IMD = -24dB(Max.)

(MIL Standard)

#### **ABSOLUTE MAXIMUM RATINGS (Tc = 25°C)**

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CBO}$	45	V
Collector-Emitter Voltage	V <sub>CES</sub>	45	V
Collector-Emitter Voltage	V <sub>CEO</sub>	18	V
Emitter-Base Voltage	V <sub>EBO</sub>	4	V
Collector Current	IC	25	Α
Collector Power Dissipation	PC	250	W
Junction Temperature	Tj	175	°C
Storage Temperature Range	T <sub>stg</sub>	-65~175	°C



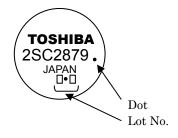
Weight: 5.2g

Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### MARKING

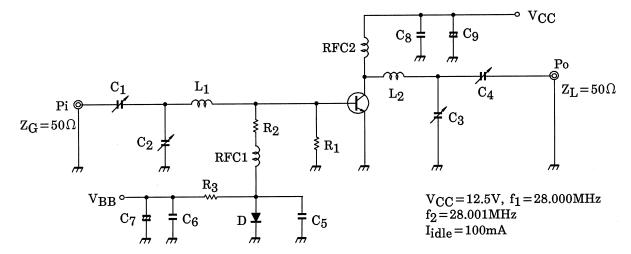


## ELECTRICAL CHARACTERISTICS (Tc = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector-Emitter Breakdown Voltage	V (BR) CEO	I <sub>C</sub> = 100mA, I <sub>B</sub> = 0	18	_	_	V
Collector-Emitter Breakdown Voltage	V (BR) CES	I <sub>C</sub> = 100mA, V <sub>EB</sub> = 0	45	_	_	V
Emitter-Base Breakdown Voltage	V (BR) EBO	I <sub>E</sub> = 1mA, I <sub>C</sub> = 0	4	_	_	V
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 10A	10	_	150	
Collector Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 12.5V, I <sub>E</sub> = 0 f = 1MHz	_	700	_	pF
Power Gain	Gp		13.0	15.2	-	dB
Input Power	Pi	$V_{CC}$ = 12.5V, $f_1$ = 28.000MHz $f_2$ = 28.001MHz	_	6	10	W <sub>PEP</sub>
Collector Efficiency	ηc	I <sub>idle</sub> = 100mA Po = 100W <sub>PFP</sub> .(Fig.)	35	_	-	%
Intermodulation Distortion	IMD		_	_	-24	dB
Series Equivalent Input Impedance	Z <sub>in</sub>	V <sub>CC</sub> = 12.5V, f = 28MHz	_	1.45 -j0.95	_	Ω
Series Equivalent Output Impedance	Z <sub>out</sub>	$\Delta f = 1 \text{kHz}$ , Po = $100 \text{W}_{\text{PEP}}$	_	1.45 -j1.0	_	Ω

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#### Fig. Pi TEST CIRCUIT



 $C_1, C_2 : 7 \sim 150 pF$ 

 $C_3$ ,  $C_4$ :  $7 \sim 150 \text{pF}$  2KWV

 $C_5, C_6 : 0.022 \mu F$ 

 $C_7$  :  $47\mu F$  10WV

C8 :  $0.044 \mu F$ 

C9 :  $100 \mu F$  50WV

L<sub>1</sub> :  $\phi$ 0.8 ENAMEL COATED COPPER WIRE, 14ID, 4T, 4P

 $\dot{\phi}_2$ :  $\dot{\phi}_1.2$  ENAMEL COATED COPPER WIRE, 14ID, 3 1/2T, 3P

RFC1:  $\phi$ 0.8mm EMAMEL COATED COPPER WIRE, 10ID, 9T

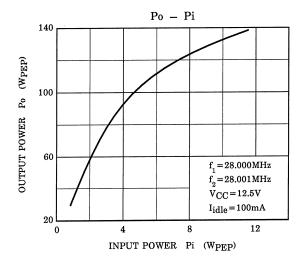
(Ferrite Core TDK K2)

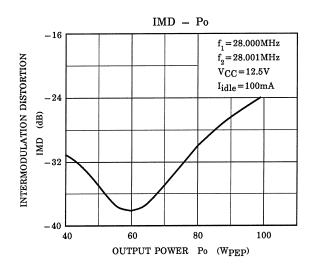
RFC2:  $\phi$ 1.8mm ENAMEL COATED COPPER WIRE, 14ID, 20T

 $R_1 : 10\Omega (1W)$ 

 $R_2 : 2\Omega (1/2W) \\ R_3 : 10\Omega (5W)$ 

D :1S1555





#### **CAUTION**

These are only typical curves and devices are not necessarily guaranteed at these curves.

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#### **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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